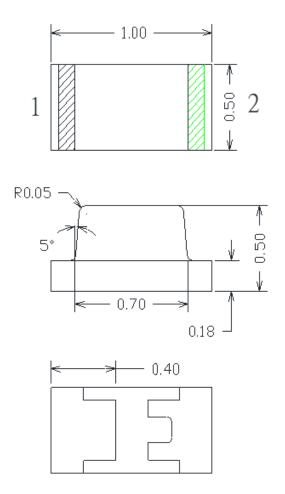
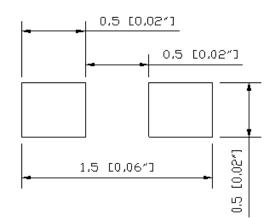


1.0 x 0.5 x 0.5mm Orange SMD LED

PACKAGE OUTLINES



RECOMMEND PAD LAYOUT





Item	Material		
Resin(Mold)	Ероху		
Lens Color	Water Transparent		
Dice	AlGaInP/GaAs		
Emitted Color	Orange		

Notes:

- 1. All dimensions are in millimeters (inches)
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted



1.0 x 0.5 x 0.5mm Orange SMD LED

ABSOLUTE MAXIMUM RATINGS			(Ta=25°C)
	Symbol	Value	Unit
Forward Current	I _F	30	mA
Reverse Voltage	Vr	5	V
Power Dissipation	PD	75	mW
Operating Temperature Range	T _{op}	-40~+80	°C
Storage Temperature Range	T _{stg}	-40~+85	°C
Peak Pulsing Current (1/8 duty f=1kHz)	I _{fp}	125	mA

OPTICAL-ELECTRICAL CHARACTERISTICS

(Ta=25°C)

	Test Condition Symbo		Value			Unit
	Test condition	Symbol	Min	Тур	Max	Onit
Wavelength at Peak Emission		λр		615		nm
Spectral Half Bandwidth		Δλ		21		nm
Dominant Wavelength	IF=20mA	λd	600	605	610	nm
Forward Voltage		Vf	1.7	2.0	2.5	V
Luminous Intensity		lv	80	130	250	mcd
Viewing Angle at 50% lv	IF=10mA	2⊖1/2		140		deg
Reverse Current	Vr=5V	lr			10	μA



1.0 x 0.5 x 0.5mm Orange SMD LED

610

Rank	Min.	Max.	Unit		
	1.7	2.5	V		
uminous Intensity	y Rank		(IF=20m/		
Rank	Min.	Max.	Unit		
I	80	100			
J	100	125			
К	125	160	mcd		
L	160	200			
Μ	200	250			
Dominant Wavelength Rank (IF=20mA					
Rank	Min.	Max.	Unit		
р	600	605			

Group Name on Label (Example DATA: DKq 20)

605

DATA: □Kq 20	Vf(V)	lv (mcd)	λd (nm)	Test Condition
$\Box \rightarrow K \rightarrow q \rightarrow 20$	1.7~2.5	125~160	605~610	IF= 20mA

Notes:

1. Tolerance of luminous intensity (lv) is ±15%

2. Tolerance of Dominant wavelength is ± 1.5nm

3. This specification is preliminary

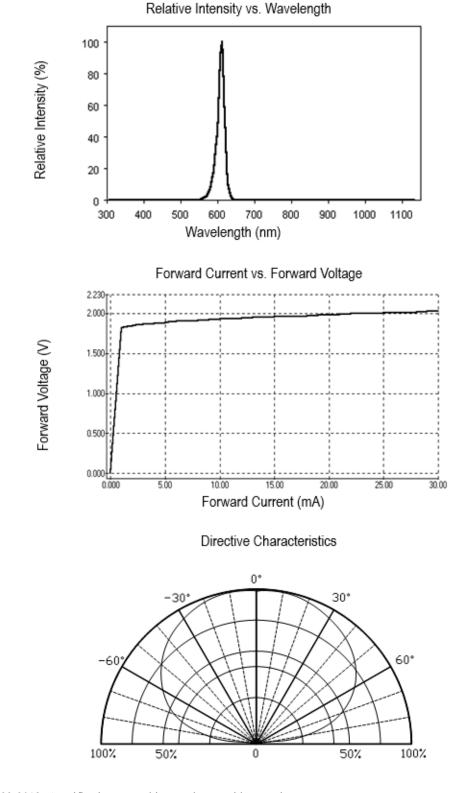
q

nm



1.0 x 0.5 x 0.5mm Orange SMD LED

OPTICAL CHARACTERISTIC CURVES

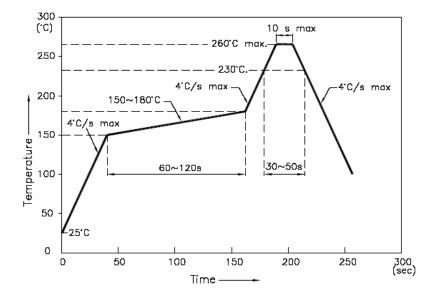




1.0 x 0.5 x 0.5mm Orange SMD LED

REFLOW PROFILE

• Reflow Temp/Time



Notes:

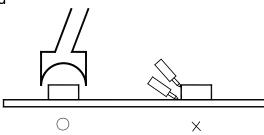
- 1. We recommend the reflow temperature 245°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Soldering iron

Basic spec is ≤ 5sec when 260°C. If temperature is higher, time should be shorter (+10°C → -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

Rework

- 1. Customer must finish rework within 5 seconds under 260°C
- 2. Head of iron cannot touch coper foil
- 3. Twin-head type is preferred



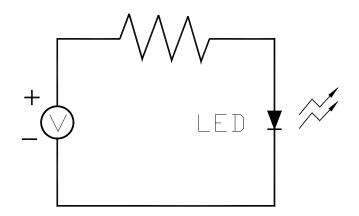
• Avoid rubbing or scraping the resin by any object during high temperature, for example, reflow solder etc.



1.0 x 0.5 x 0.5mm Orange SMD LED

TEST CIRCUIT AND HANDLING PRECAUTIONS

• Test circuit



- Handling precautions
- 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will causebig current change (Burn out will happen).

- 2. Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H;
- 3. After the package is opened:
- 3.1 It is recommended to baking before the first use: Baking condition:
 - a. $60\pm5^{\circ}C \times (24\sim48hrs)$ and <5%RH, taped reel type ;
 - b. 110±5°C x (8~16hr), bulk type ;
- 3.2 The products should be used within a week and to be store at ≤20% R.H. with zip-lock sealed
 - a. Baking is required before soldering when the pack is unsealed after 24hrs ;
 - b. Baking condition as 3.1 baking condition.



1.0 x 0.5 x 0.5mm Orange SMD LED

TEST AND RESULTS OF RELIABLITY

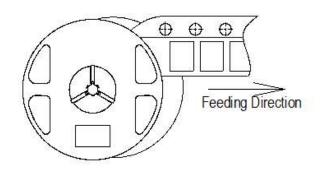
Туре	Test Item	Test Conditions	Note	Number of Damaged
	Temperature Cycle	-20°C 30min ↑↓ 80°C 30min	100 cycle	0/22
	Thermal Shock	-20°C 15min ↑↓ 80°C 15min	100 cycle	0/22
Environmental Sequence	High Humidity Heat Cycle	30°C⇔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
Envirol Sequ	High Temperature Storage	T _a =80°C	1000 hrs	0/22
	Humidity Heat Storage	T _a =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	T _a =-30°C	1000 hrs	0/22
	Life Test	T _a =25°C I _F =20mA	1000 hrs	0/22
Operation Sequence	High Humidity Heat Life Test	60°C RH=90% I _F =10mA	500 hrs	0/22
0 0	Low Temperature Life Test	T _a =-20°C I _F =20mA	1000 hrs	0/22



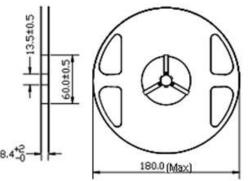
1.0 x 0.5 x 0.5mm Orange SMD LED

PACKAGING SPECIFICATION

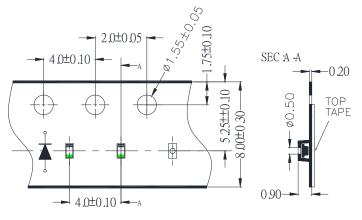
• Feeding Direction



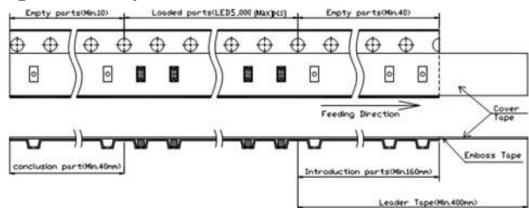
Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



Arrangement of Tape



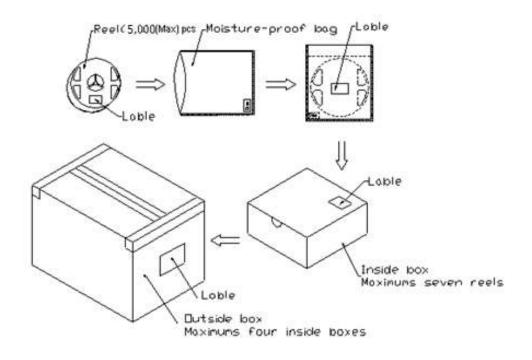
Notes:

- 1. Empty component pockets are sealed with top cover tape
- 2. The maximum number of missing lamps is two
- 3. The cathode is oriented towards the tape sprocket hole
- 4. 5,000(Max) pcs/Reel



1.0 x 0.5 x 0.5mm Orange SMD LED

PACKAGING SPECIFICATION



Notes:

Reeled products [numbers of products are 5,000(Max)pcs] packed in a seal off moistureproof bag along with a desiccant one by one, Seven moisture-proof bag of maximums [total maximum number of products are 35,000(Max)pcs] packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.